



LMH3401IRMS can be used for U1.
If LMH3401IRMS used for U1 Rf1+ and Rf1- can be unpopulated (open).

LMH3401IRMS can be used for U2.
If LMH3401IRMS used for U2 Rf2+ and Rf2- can be unpopulated (open).



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Orderable: EVM, orderable	Designed for: Public Release	Mod. Date: 12/3/2015
TID #: TIDA-0659	Project Title: CASCADED LMH5401	
Number: 6593182	Rev: A	Sheet Title:
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 1 of 2
Drawn By: Bob Holtz	File: CASCADED LMH5401-A AMP.SchDoc	Size: B
Engineer: Loren Siebert	Contact: http://www.ti.com/support	



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1 2 3 4 5 6

A

A

PCB Number: 6593182
PCB Rev: A

PCB
LOGO
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PCB
LOGO
Pb-Free Symbol

PCB
LOGO
FCC disclaimer

B

B

C

C

ZZ2

Assembly Note

These assemblies are ESD sensitive. ESD precautions shall be observed.

ZZ3

Assembly Note

These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4

Assembly Note

These assemblies must comply with workmanship standards IPC-A-610 Class 2., unless otherwise specified.

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